

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re New Patent Application of)
Shunpei YAMAZAKI et al.)
Japanese Priority Application No. 2001-040848) Attn: Applications
Japanese Priority Date: February 16, 2001) Branch
For: METHOD OF MANUFACTURING A)
SEMICONDUCTOR DEVICE) Date: February 14, 2002

#4/IDS
Ame
SP/02



INFORMATION DISCLOSURE STATEMENT

Honorable Commissioner for Patents and Trademarks
Washington, D.C. 20231

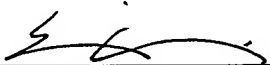
Sir:

In accordance with the provisions of 37 C.F.R. 1.56 and 37 C.F.R. 1.97-1.99, it is requested that the references listed on the attached Form PTO-1449 be made of record in the above-identified application.

Copies of these references are submitted herewith in accordance with 37 C.F.R. 1.98(a).

U.S. Patent No. 5,643,826 is listed in the patent family of Japanese Patent Laid-Open No. 07-183540.

Respectfully submitted,


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INFORMATION DISCLOSURE STATEMENT BY APPLICANT <i>(use as many sheets as necessary)</i>				Complete if Known				
				Application Number				
				Filing Date		February 12, 2002		
				First Named Inventor		Shunpei YAMAZAKI		
				Group Art Unit				
				Examiner Name				
Sheet	1	of	1	Attorney Docket Number		740756-2434		
U.S. PATENT DOCUMENTS								
Examiner Initials*	Cite No. ¹	U.S. Patent Document		Name of Patentee or Applicant of Cited Document	Date of Publication of Cited Document MM-DD-YYYY	Pages, Columns, Lines, Where Relevant Passages or Relevant Figures Appear		
		Number	Kind Code ² (if known)					
		5,643,826		Ohtani et al.	07/01/1997			
		5,932,893		Miyanaaga et al.	08/03/1999			
		5,789,284		Yamazaki et al.	08/04/1998			
		6,071,766		Yamazaki et al.	06/06/2000			
		5,700,333		Yamazaki et al.	12/23/1997			
		5,961,743		Yamazaki et al.	10/05/1999			
FOREIGN PATENT DOCUMENTS								
Examiner Initials*	Cite No. ¹	Foreign Patent Document		Name of Patentee or Applicant of Cited Document	Date of Publication of Cited Document MM-DD-YYYY	Pages, Columns, Lines, Where Relevant Passages or Relevant Figures Appear		T ⁶
		Office ³	Number ⁴ Kind Code ² (if known)					
		Japan	07-183540		07/21/1995			Abstract
OTHER PRIOR ART - NON PATENT LITERATURE DOCUMENTS								
Examiner Initials*	Cite No. ¹	Include name of the author (in CAPITAL LETTERS), title of the article (when appropriate), title of the item (book, magazine, journal, serial, symposium, catalog, etc.), date, page(s), volume-issue number(s), publisher, city and/or country where published.						T ²
Examiner Signature					Date Considered			

*EXAMINER: Initial if reference considered, whether or not citation is in conformance with MPEP 609. Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant.

¹ Unique citation designation number. ² See attached Kinds of U.S. Patent Documents. ³ Enter Office that issued the document, by the two-letter code (WIPO Standard ST.3). ⁴ For Japanese patent documents, the indication of the year of the reign of the Emperor must precede the serial number of the patent document. ⁵ Kind of document by the appropriate symbols as indicated on the document under WIPO Standard ST.16 if possible. ⁶ Applicant is to place a check mark here if English language Translation is attached.

¹ Unique citation designation number. ² Applicant is to place a check mark here if English language Translation is attached.

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